

2SK3904

Switching Regulator Applications

- Low drain-source ON resistance: $R_{DS(ON)} = 0.2\ \Omega$ (typ.)
- High forward transfer admittance: $|Y_{fs}| = 9.5\ S$ (typ.)
- Low leakage current: $I_{DSS} = 100\ \mu A$ (max) ($V_{DS} = 450\ V$)
- Enhancement model: $V_{th} = 2.0\sim 4.0\ V$ ($V_{DS} = 10\ V$, $I_D = 1\ mA$)

Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	450	V
Drain-gate voltage ($R_{GS} = 20\ k\Omega$)		V_{DGR}	450	V
Gate-source voltage		V_{GSS}	± 30	V
Drain current	DC (Note 1)	I_D	19	A
	Pulse (Note 1)	I_{DP}	76	
Drain power dissipation ($T_c = 25^\circ C$)		P_D	150	W
Single pulse avalanche energy (Note 2)		E_{AS}	820	mJ
Avalanche current		I_{AR}	19	A
Repetitive avalanche energy (Note 3)		E_{AR}	15	mJ
Channel temperature		T_{ch}	150	°C
Storage temperature range		T_{stg}	$-55\sim 150$	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristic	Symbol	Max	Unit
Thermal resistance, channel to case	$R_{th(ch-c)}$	0.833	°C/W
Thermal resistance, channel to ambient	$R_{th(ch-a)}$	50	°C/W

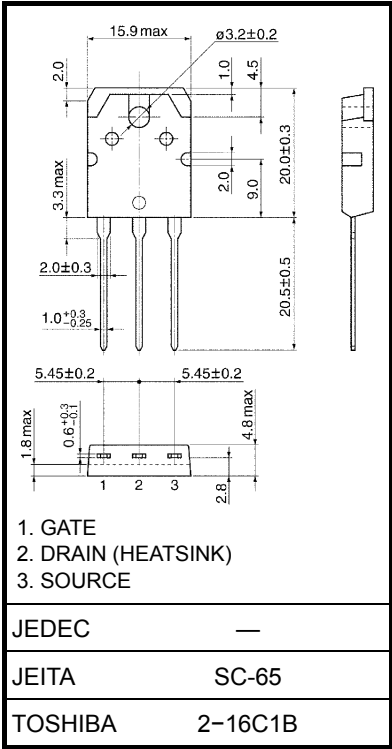
Note 1: Ensure that the channel temperature does not exceed 150°C during use of the device.

Note 2: $V_{DD} = 90\ V$, $T_{ch} = 25^\circ C$, $L = 3.79\ mH$, $R_G = 25\ \Omega$, $I_{AR} = 19\ A$

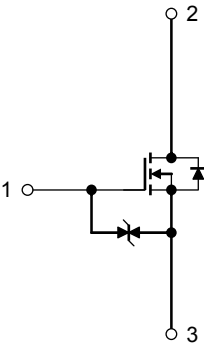
Note 3: Repetitive rating: pulse width limited by max junction temperature

This transistor is an electrostatic-sensitive device. Handle with care.

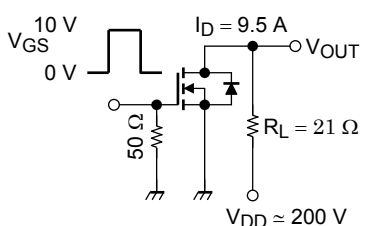
Unit: mm



Weight: 4.6 g (typ.)



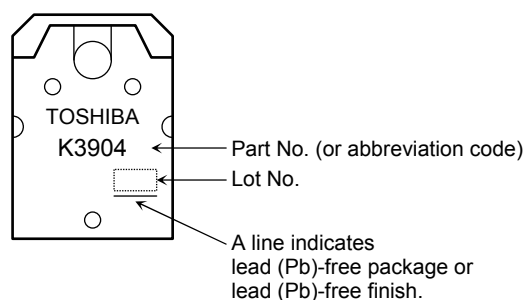
Electrical Characteristics (Ta = 25°C)

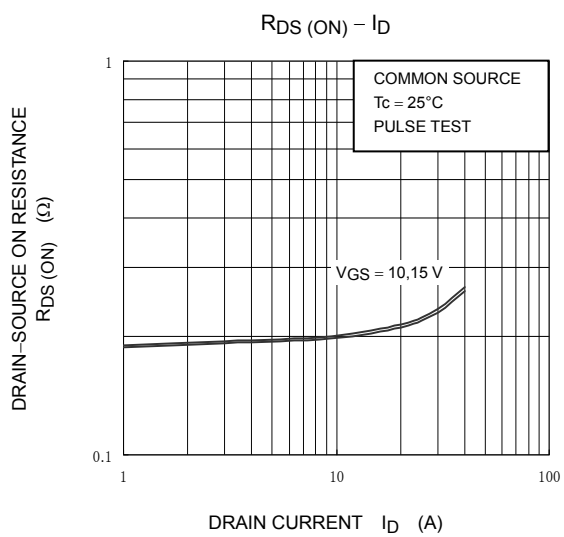
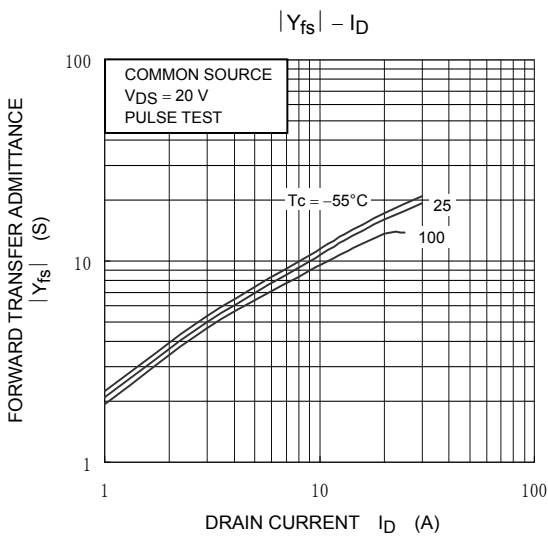
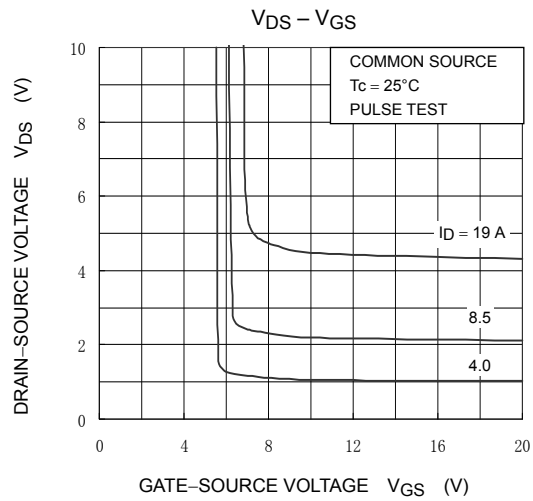
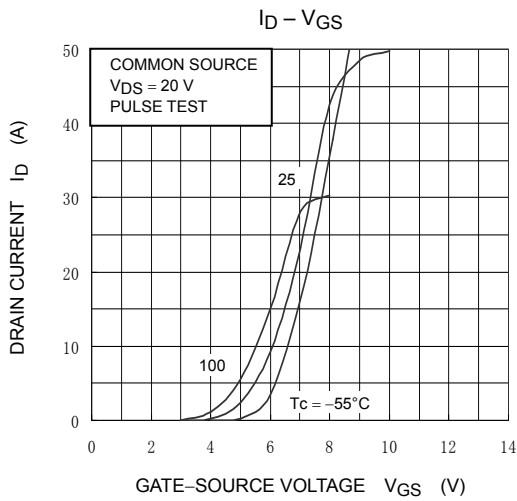
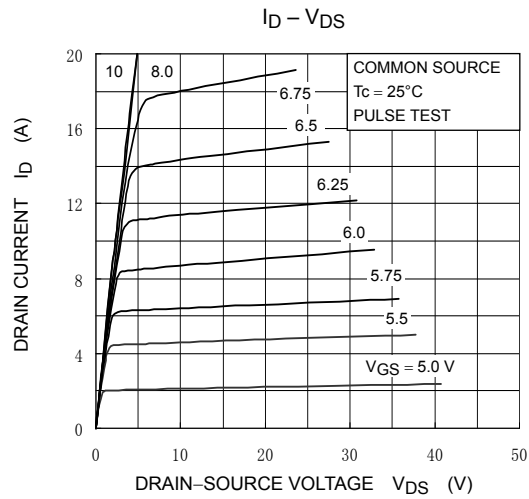
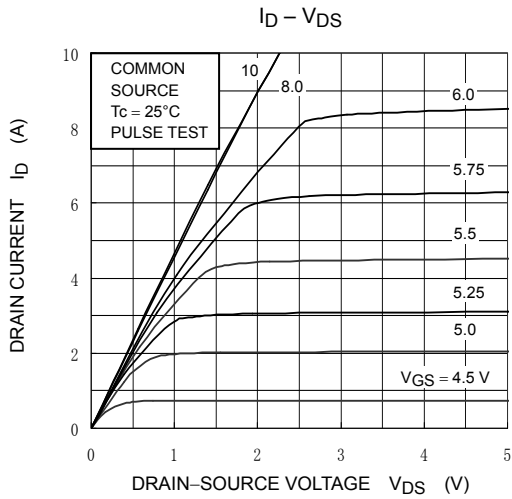
Characteristic		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		I_{GSS}	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$	—	—	± 10	μA
Drain-source breakdown voltage		$V_{(BR)GSS}$	$I_G = \pm 10 \mu\text{A}, V_{DS} = 0 \text{ V}$	± 30	—	—	V
Drain cut-off current		I_{DSS}	$V_{DS} = 450 \text{ V}, V_{GS} = 0 \text{ V}$	—	—	100	μA
Drain-source breakdown voltage		$V_{(BR)DSS}$	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	450	—	—	V
Gate threshold voltage		V_{th}	$V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$	2.0	—	4.0	V
Drain-source ON resistance		$R_{DS(ON)}$	$V_{GS} = 10 \text{ V}, I_D = 9.5 \text{ A}$	—	0.2	0.26	Ω
Forward transfer admittance		$ Y_{fs} $	$V_{DS} = 10 \text{ V}, I_D = 9.5 \text{ A}$	2.6	9.5	—	S
Input capacitance		C_{iss}	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	—	3100	—	pF
Reverse transfer capacitance		C_{rss}		—	20	—	
Output capacitance		C_{oss}		—	270	—	
Switching time	Rise time	t_r	 $V_{GS} = 10 \text{ V}$ 0 V 50Ω $I_D = 9.5 \text{ A}$ $R_L = 21 \Omega$ $V_{DD} \approx 200 \text{ V}$ $\text{Duty} \leq 1\%, t_w = 10 \mu\text{s}$	—	70	—	ns
	Turn-on time	t_{on}		—	130	—	
	Fall time	t_f		—	70	—	
	Turn-off time	t_{off}		—	280	—	
Total gate charge (gate-source plus gate-drain)		Q_g	$V_{DD} \approx 360 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 19 \text{ A}$	—	62	—	nC
Gate-source charge		Q_{gs}		—	40	—	
Gate-drain ("Miller") charge		Q_{gd}		—	22	—	

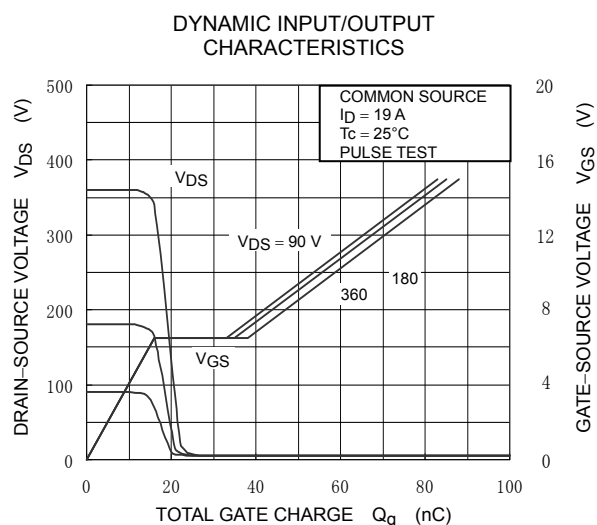
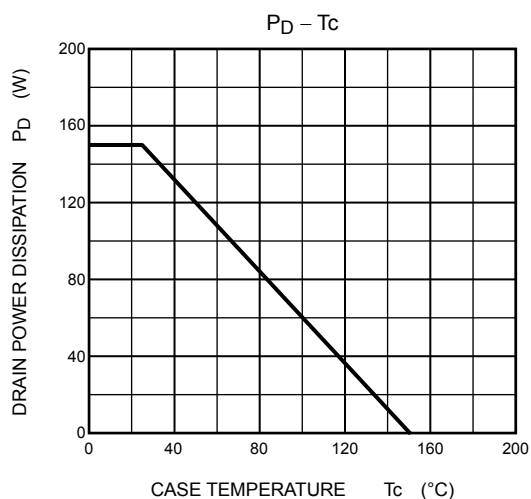
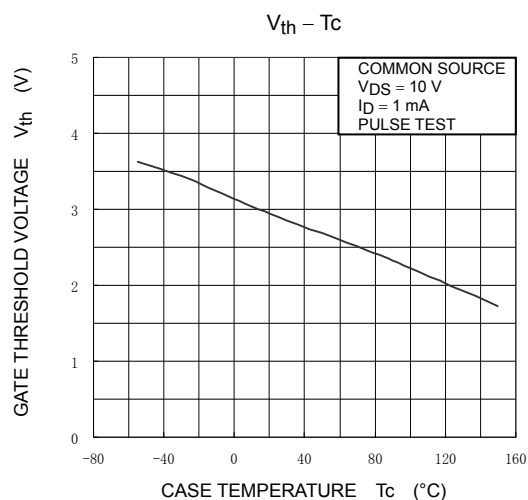
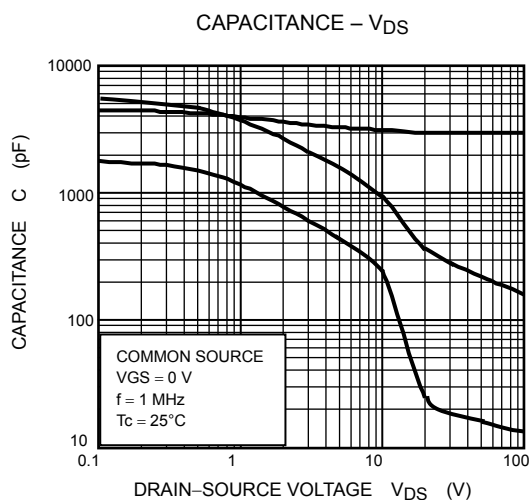
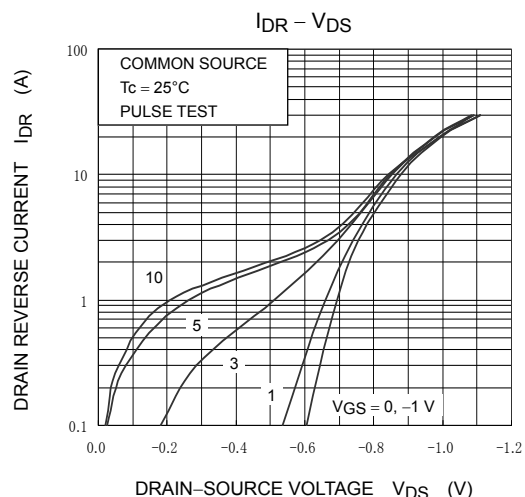
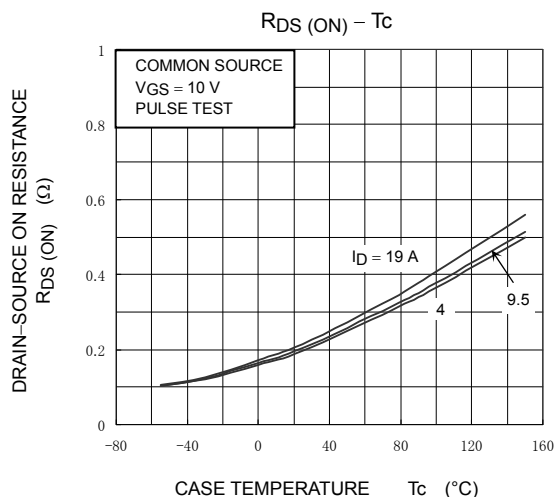
Source-Drain Ratings and Characteristics (Ta = 25°C)

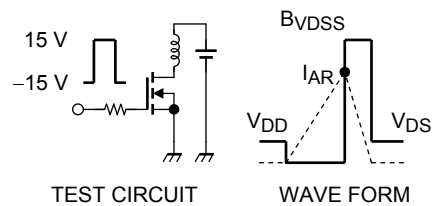
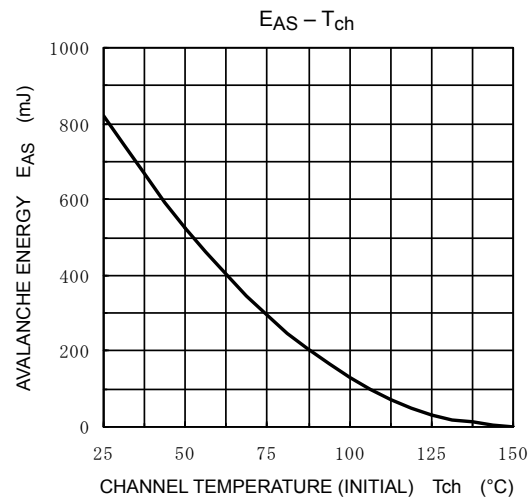
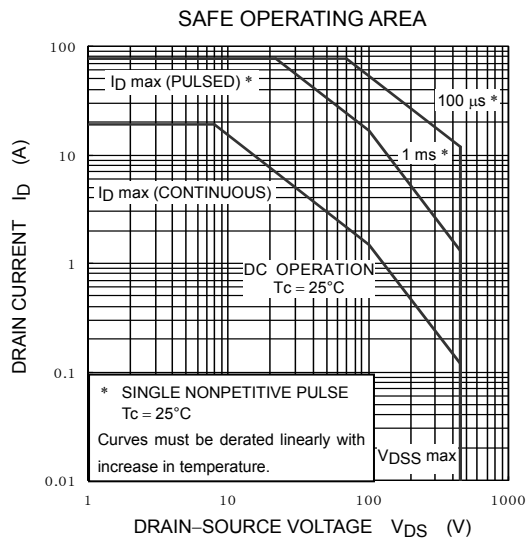
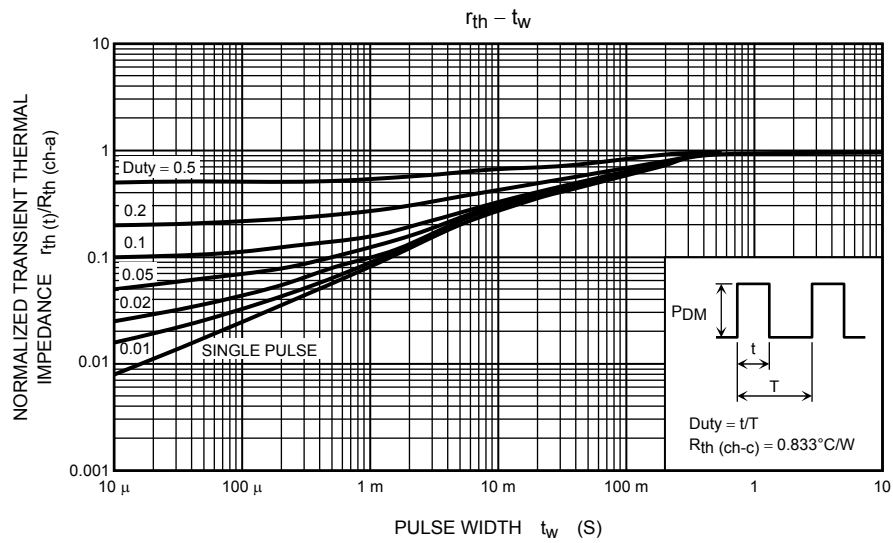
Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Continuous drain reverse current (Note 1)	I_{DR}	—	—	—	19	A
Pulse drain reverse current (Note 1)	I_{DRP}	—	—	—	76	A
Forward voltage (diode)	V_{DSF}	$I_{DR} = 19 \text{ A}, V_{GS} = 0 \text{ V}$	—	—	-1.7	V
Reverse recovery time	t_{rr}	$I_{DR} = 19 \text{ A}, V_{GS} = 0 \text{ V},$	—	1300	—	μs
Reverse recovery charge	Q_{rr}	$dI_{DR}/dt = 100 \text{ A}/\mu\text{s}$	—	18	—	μC

Marking









$$R_G = 25 \, \Omega$$

$$V_{DD} = 90 \, V, L = 3.79 \, mH$$

$$E_{AS} = \frac{1}{2} \cdot L \cdot I_{AS}^2 \cdot \left(\frac{BVDSS}{BVDSS - V_{DD}} \right)$$

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